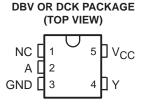
- **Available in the Texas Instruments** NanoStar™ and NanoFree™ Packages
- Low Static-Power Consumption; $I_{CC} = 0.9 - \mu A Max$
- Low Dynamic-Power Consumption; $C_{pd} = 4.4 \text{ pF Typical at 3.3 V}$
- Low Input Capacitance; C_i = 1.5 pF Typical
- Low Noise Overshoot and Undershoot <10% of V_{CC}
- **I**off Supports Partial-Power-Down Mode Operation
- **Includes Schmitt-Trigger Inputs**
- Wide Operating V_{CC} Range of 0.8 V to 3.6 V
- **Optimized for 3.3-V Operation**

- 3.6-V I/O Tolerant to Support Mixed-Mode **Signal Operation**
- $t_{pd} = 4.9 \text{ ns Max at } 3.3 \text{ V}$
- **Suitable for Point-to-Point Applications**
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- **ESD Performance Tested Per JESD 22**
 - 2000-V Human-Body Model (A114-B, Class II)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- ESD Protection Exceeds ±5000-V With **Human-Body Model**

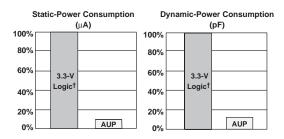


NC - No internal connection



description/ordering information

The AUP family is TI's premier solution to the industry's low-power needs in battery-powered portable applications. This family ensures a very low static and dynamic power consumption across the entire V_{CC} range of 0.8 V to 3.6 V, resulting in an increased battery life. This product also maintains excellent signal integrity (see Figures 1 and 2).



[†] Single, dual, and triple gates.

0.5 \dagger AUP1G08 data at C_L = 15 pF.

3.5

2.5

1.5

2

Input

10 15 20 25

Figure 2. Excellent Signal Integrity

Switching Characteristics

at 25 MHz†

Output

Figure 1. AUP-The Lowest-Power Family

This device functions as an independent gate with Schmitt-trigger inputs, which allows for slow input transition and better switching-noise immunity at the input.

NanoStar™ and NanoFree™ package technology is a major breakthrough in IC packaging concepts, using the die as the package.



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35 40

description/ordering information (continued)

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

TA	PACKAGE [†]	ORDERABLE PART NUMBER	TOP-SIDE MARKING‡		
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	D I . (0000	SN74AUP1G14YEPR		
	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	Reel of 3000	SN74AUP1G14YZPR	HF_	
–40°C to 85°C	007 (007 00) DDV	Reel of 3000	SN74AUP1G14DBVR		
	SOT (SOT-23) – DBV	Reel of 250	SN74AUP1G14DBVT	H14_	
	SOT (SC 70) DCK	Reel of 3000	SN74AUP1G14DCKR	HF	
	SOT (SC-70) – DCK	Reel of 250	SN74AUP1G14DCKT	пг_	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

INPUT A	OUTPUT Y
Н	L
L	Н

logic diagram (positive logic)



DBV/DCK: The actual top-side marking has one additional character that designates the assembly/test site. YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, • = Pb-free).

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	
Voltage range applied to any output in the high-impedance or power-off state, V _O	=0.5 v to 4.6 v
	0.5.\/
(see Note 1)	
Output voltage range in the high or low state, V _O (see Note 1)	$-0.5 \text{ V to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I _{IK} (V _I < 0)	–50 mA
Output clamp current, I _{OK} (V _O < 0)	
Continuous output current, I _O	
Continuous current through V _{CC} or GND	
Package thermal impedance, θ_{JA} (see Note 2): DBV package	
DCK package	
YEP/YZP package	
Storage temperature range, T _{stq}	

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and outpu negative-voltaget ratings may be exceeded if the input and output current ratings are observed.

2. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Note 3)

			MIN	MAX	UNIT	
VCC	Supply voltage		0.8	3.6	V	
٧ _I	Input voltage		0	3.6	V	
٧o	Output voltage		0	VCC	V	
		V _{CC} = 0.8 V		-20	μΑ	
		V _{CC} = 1.1 V		-1.1		
I _{OH} ‡	High-level output current	V _{CC} = 1.4 V		-1.7		
		V _{CC} = 1.65		-1.9	mA	
		V _{CC} = 2.3 V		-3.1		
		VCC = 3 V		-4		
		V _{CC} = 0.8 V		20	μΑ	
		V _{CC} = 1.1 V		1.1		
. +	Lavaland advitantance	V _{CC} = 1.4 V		1.7		
loL‡	Low-level output current	V _{CC} = 1.65 V		1.9	mA	
		V _{CC} = 2.3 V		3.1		
		VCC = 3 V		4		
Δt/Δν	Input transition rise or fall rate	V _{CC} = 0.8 V to 3.6 V		200	ns/V	
T _A	Operating free-air temperature	-40	85	°C		

[‡] Defined by the signal-integrity requirements and design-goal priorities.

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIO	NC			Γ _A = 25 °C	T _A = −40 °0	C TO 85 °C			
PARAMETER	TEST CONDITIO	N5	VCC	MIN	TYP MAX	MIN	MAX	UNIT		
			0.8 V	0.3	0.6	0.3	0.6			
V _{T+}			1.1 V	0.53	0.9	0.53	0.9			
Positive-going			1.4 V	0.74	1.11	0.74	1.11	,,		
input threshold			1.65 V	0.91	1.29	0.91	1.29	V		
voltage			2.3 V	1.37	1.77	1.37	1.77			
			3 V	1.88	2.29	1.88	2.29			
			0.8 V	0.1	0.6	0.1	0.6]		
V _T _			1.1 V	0.26	0.65	0.26	0.65			
Negative-going			1.4 V	0.39	0.75	0.39	0.75] ,,		
input threshold			1.65 V	0.47	0.84	0.47	0.84	V		
voltage			2.3 V	0.69	1.04	0.69	1.04			
			3 V	0.88	1.24	0.88	1.24			
			0.8 V	0.07	0.5	0.07	0.5			
			1.1 V	0.08	0.46	0.08	0.46			
ΔVT			1.4 V	0.18	0.56	0.18	0.56] ,,		
Hysteresis (V _{T+} – V _T –)			1.65 V	0.27	0.66	0.27	0.66	V		
(*1+ *1-)			2.3 V	0.53	0.92	0.53	0.92			
			3 V	0.79	1.31	0.79	1.31			
	I _{OH} = -20 μA		0.8 V to 3.6 V	V _{CC} - 0.1		V _{CC} – 0.1				
	I _{OH} = -1.1 mA		1.1 V	0.75 × V _{CC}	;	0.7 × V _{CC}				
	I _{OH} = -1.7 mA		1.4 V	1.11		1.03				
	I _{OH} = -1.9 mA		1.65 V	1.32		1.3		,,		
VOH	$I_{OH} = -2.3 \text{ mA}$		221	2.05		1.97		V		
	I _{OH} = -3.1 mA		2.3 V	1.9		1.85				
	$I_{OH} = -2.7 \text{ mA}$		0.17	2.72		2.67				
	$I_{OH} = -4 \text{ mA}$		3 V	2.6		2.55				
	I _{OL} = 20 μA		0.8 V to 3.6 V		0.1		0.1			
	I _{OL} = 1.1 mA		1.1 V		0.3 × V _{CC}		$0.3 \times V_{CC}$			
	I _{OL} = 1.7 mA		1.4 V		0.31		0.37			
l .,	I _{OL} = 1.9 mA		1.65 V		0.31		0.35	,,		
VOL	I _{OL} = 2.3 mA		0.01/		0.31		0.33	V		
	I _{OL} = 3.1 mA		2.3 V		0.44		0.45			
	I _{OL} = 2.7 mA		- 1/		0.31		0.33			
	I _{OL} = 4 mA		3 V		0.44		0.45	1		
I _I A input	V _I = GND to 3.6 V		0 V to 3.6 V		0.1		0.5	μΑ		
l _{off}	V_{1} or $V_{0} = 0 \text{ V to } 3.6 \text{ V}$		0 V		0.2		0.6	μА		
Δl _{off}	V _I or V _O = 0 V to 3.6 V		0 V to 0.2 V		0.2		0.6	μΑ		
Icc	V _I = GND or (V _{CC} to 3.6 V)	I _O = 0	0.8 V to 3.6 V		0.5		0.9	μА		
ΔICC	VI = VCC - 0.6 V	I _O = 0	3.3 V		40		50	μА		



electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	UNIT
C	V _I = V _{CC} or GND	0 V		1.5				pF
Ci		3.6 V		1.5				рг
Co	$V_O = GND$	0 V		2.5				pF

switching characteristics over recommended operating free-air temperature range, $C_L = 5$ pF (unless otherwise noted) (see Figures 3 and 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	T _A = 25 °C			T _A = -40 °C TO 85 °C		UNIT
				MIN	TYP	MAX	MIN	MAX	
			0.8 V		16.3				
		Y	1.2 V ± 0.1 V	4.2	6.9	11.7	0.9	15	ns
	A		1.5 V ± 0.1 V	3.7	5.2	8.4	1.7	10.7	
^t pd	А		1.8 V ± 0.15 V	3.3	4.4	6.9	1.9	8.5	
			2.5 V ± 0.2 V	2.8	3.5	4.8	1.8	6.1	
			3.3 V ± 0.3 V	2.5	3	4	1.7	4.9	

switching characteristics over recommended operating free-air temperature range, $C_L = 10 \text{ pF}$ (unless otherwise noted) (see Figures 3 and 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	T _A = 25 °C			T _A = -40 °C TO 85 °C		UNIT
				MIN	TYP	MAX	MIN	MAX]
			0.8 V		18.4				
	А	Y	1.2 V ± 0.1 V	4.6	7.9	13.4	1.3	16.7	ns
			1.5 V ± 0.1 V	4	6	9.6	2.2	11.8	
^t pd			1.8 V ± 0.15 V	3.6	5	7.9	2.4	9.5	
			2.5 V ± 0.2 V	3.2	4	5.5	2.3	6.8	
			3.3 V ± 0.3 V	2.9	3.5	4.6	2.1	5.6	

switching characteristics over recommended operating free-air temperature range, C_L = 15 pF (unless otherwise noted) (see Figures 3 and 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	Vcc	T _A = 25 °C			T _A = -40 °C TO 85 °C		UNIT
				MIN	TYP	MAX	MIN	MAX]
			0.8 V		20.1				
			1.2 V ± 0.1 V	5.5	8.7	14	2.5	17.3	
		Y	1.5 V ± 0.1 V	4.7	6.7	10	3	12.5	ns
^t pd	A		1.8 V ± 0.15 V	4.2	5.6	8.3	3	10.1	
			2.5 V ± 0.2 V	3.6	4.5	5.9	2.7	7.4	
			3.3 V ± 0.3 V	3.3	3.9	5	2.5	6.1	

SN74AUP1G14 LOW-POWER SINGLE SCHMITT-TRIGGER INVERTER

SCES578 - JUNE 2004

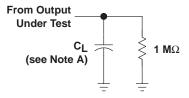
switching characteristics over recommended operating free-air temperature range, C_L = 30 pF (unless otherwise noted) (see Figures 3 and 4)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	v _{cc}	T _A = 25 °C			T _A = -40 °C TO 85 °C		UNIT
				MIN	TYP	MAX	MIN	MAX	
			0.8 V		25.7				
	А	Y	1.2 V ± 0.1 V	7.4	11.2	17.1	4.5	20.5	ns
.			1.5 V ± 0.1 V	6.1	8.5	12.3	4.6	14.7	
^t pd			1.8 V ± 0.15 V	5.4	7.2	10.3	4.1	12	
			2.5 V ± 0.2 V	4.7	5.7	7.4	3.7	8.8	
			3.3 V ± 0.3 V	4.2	5	6.2	3.5	7.3	

operating characteristics, $T_A = 25^{\circ}C$

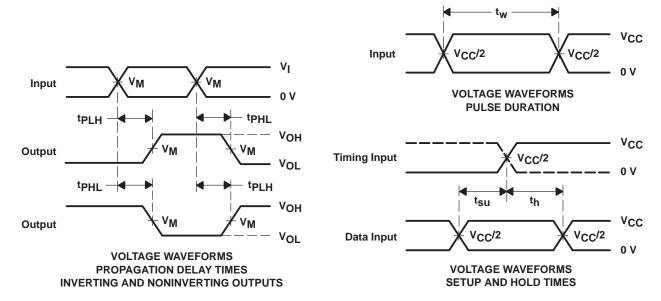
	PARAMETER	TEST CONDITIONS	VCC	TYP	UNIT
	Power dissipation capacitance		0.8 V	4	
			1.2 V ± 0.1 V	4	
٠.		f = 10 MHz	1.5 V ± 0.1 V	4.1	pF
C _{pd}			1.8 V ± 0.15 V	4.1	
			2.5 V ± 0.2 V	4.3	
			3.3 V ± 0.3 V	4.4	

PARAMETER MEASUREMENT INFORMATION (Propagation Delays, Setup and Hold Times, and Pulse Width)



LOAD CIRCUIT

V _{CC} = 0.8 V		V _{CC} = 1.2 V ± 0.1 V	V _{CC} = 1.5 V ± 0.1 V	V _{CC} = 1.8 V ± 0.15 V	V_{CC} = 2.5 V \pm 0.2 V	V _{CC} = 3.3 V ± 0.3 V
C _L	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF
V _M	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2
V _I	V _{CC}	V _{CC}	V _{CC}	V _{CC}	V _{CC}	V _{CC}

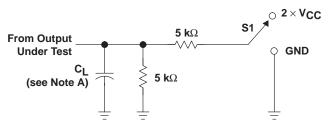


NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_r/t_f = 3$ ns.
- C. The outputs are measured one at a time, with one transition per measurement.
- D. tpLH and tpHL are the same as tpd.
- E. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

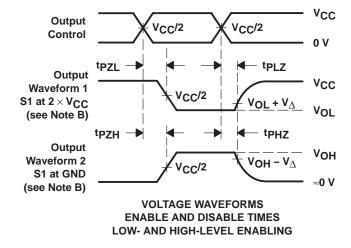
PARAMETER MEASUREMENT INFORMATION (Enable and Disable Times)



TEST	S1	
t _{PLZ} /t _{PZL}	2×V _{CC} GND	

LOAD CIRCUIT

	V _{CC} = 0.8 V	V _{CC} = 1.2 V ± 0.1 V	V _{CC} = 1.5 V ± 0.1 V	V _{CC} = 1.8 V ± 0.15 V	V _{CC} = 2.5 V ± 0.2 V	V _{CC} = 3.3 V ± 0.3 V
C _L	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF	5, 10, 15, 30 pF
V _M	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2	V _{CC} /2
V _I	V _{CC}	V _{CC}	V _{CC}	V _{CC}	V _{CC}	V _{CC}
V _∆	0.1 V	0.1 V	0.1 V	0.15 V	0.15 V	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

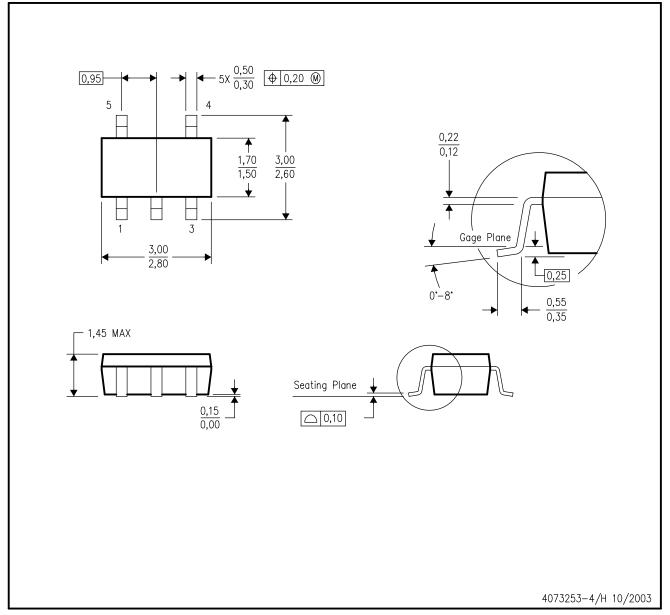
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, $Z_O = 50 \Omega$, $t_T/t_f = 3$ ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. tpLz and tpHz are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms



DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



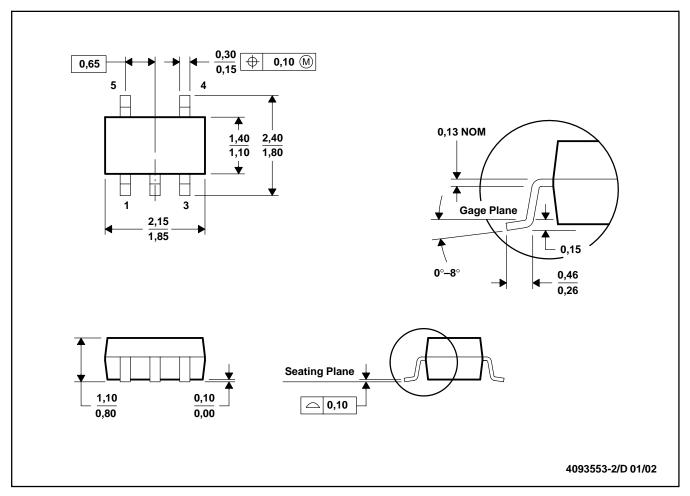
NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion.

D. Falls within JEDEC MO-203

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